

BLC Series - Basic Compact Pressure Sensor Series

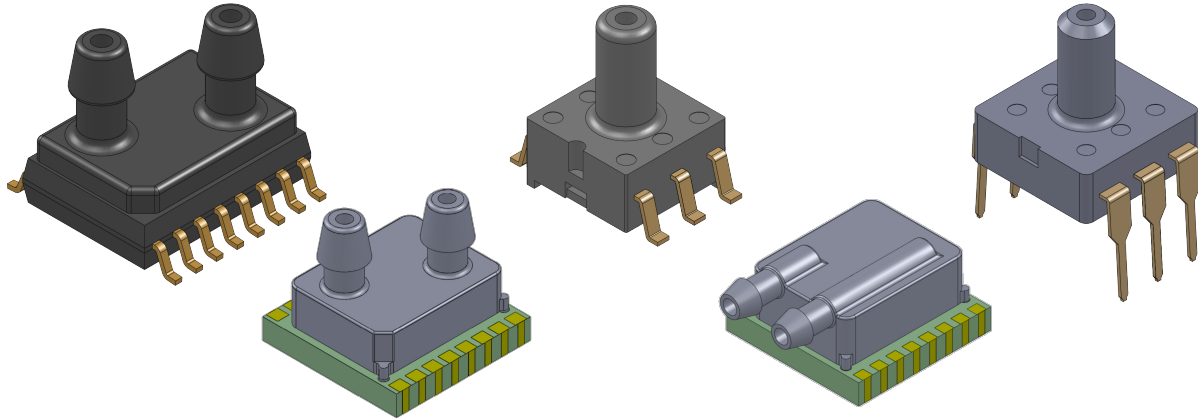


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Introduction

The BLC Series Basic Low Pressure Compact Sensor is based on All Sensors' CoBeam²™ Technology. The device provides a high output signal at a low operating voltage and reduces the overall supply voltage while maintaining comparable output levels to traditional equivalent basic sensing elements. This lower supply voltage gives rise to improved warm-up shift while the CoBeam² Technology itself reduces package stress susceptibility resulting in improved overall long term stability. The technology also vastly improves position sensitivity compared to conventional single die devices.

This series is intended for use with non-corrosive, non-ionic working fluids such as air, dry gases and the like. The output is also ratiometric to the supply voltage and is operable from 0.9 to 1.8 volts DC.

<https://www.allsensors.com/products/blc-series>



All Sensors Corporation's Quality Management System has been certified by TUV SUD in accordance with the ISO 9001:2015 Standard.



BLC SERIES BASIC COMPACT PRESSURE SENSORS

Features		Applications	
<ul style="list-style-type: none"> • Pressure Ranges from 0 to 30 inH₂O, 5 PSI to 150 PSI, and 5 PSIA to 150 PSIA • μPower Low Supply Voltage (0.9V to 1.8V) • 0.1% Linearity Typical • Improved Front to Back Linearity • Less Position Sensitivity • Improved Warm-Up Shift Distribution 		<ul style="list-style-type: none"> • Medical Breathing • Environmental Controls • HVAC • Portable / Hand-Held Devices 	
Pressure Sensor Maximum Ratings		Environmental Specifications	
Supply Voltage (Vs)	6 Vdc	Temperature Ranges	Operating -25°C to 85°C Storage -40°C to 125°C
Common Mode Pressure	5 psig		
Lead Temperature (soldering 2-4 sec.)	270°C	Humidity Limits (non condensing)	0 to 95% RH
Maximum Device Temperature	245°C		

Standard Pressure Ranges

Low Pressure Products

Device	Operating Range ^A		Proof Pressure		Burst Pressure	
BLC-L01D	± 1 inH ₂ O	248.84 Pa	100 inH ₂ O	24.88 kPa	300 inH ₂ O	74.65 kPa
BLC-L05D	± 5 inH ₂ O	1,244.20 Pa	200 inH ₂ O	49.77 kPa	300 inH ₂ O	74.65 kPa
BLC-L10D	± 10 inH ₂ O	2,488.40 Pa	200 inH ₂ O	49.77 kPa	300 inH ₂ O	74.65 kPa
BLC-L20D	± 20 inH ₂ O	4,976.80 Pa	200 inH ₂ O	49.77 kPa	500 inH ₂ O	124.42 kPa
BLC-L30D	± 30 inH ₂ O	7,465.20 Pa	200 inH ₂ O	49.77 kPa	500 inH ₂ O	124.42 kPa

High Pressure Products

Device	Operating Range ^A		Proof Pressure		Burst Pressure	
BLC-005D	± 5 psi	34.47 kPa	10 psi	68.95 kPa	15 psi	103.42 kPa
BLC-015D	± 15 psi	103.42 kPa	30 psi	206.84 kPa	45 psi	310.26 kPa
BLC-030D	± 30 psi	206.84 kPa	60 psi	413.69 kPa	90 psi	620.53 kPa
BLC-100D	± 100 psi	689.48 kPa	200 psi	1,378.95 kPa	225 psi	1,551.32 kPa
BLC-150D	± 150 psi	1,034.20 kPa	225 psi	1,551.32 kPa	225 psi	1,551.32 kPa
BLC-015A	0 to 15 psia	1.03 barA	30 psi	2.06 barA	45 psi	3.10 barA
BLC-030A	0 to 30 psia	2.06 barA	60 psi	4.14 barA	90 psi	6.20 barA
BLC-100A	0 to 100 psia	6.89 barA	200 psi	13.79 barA	225 psi	15.51 barA
BLC-150A	0 to 150 psia	10.34 barA	225 psi	15.51 barA	225 psi	15.51 barA

Note A: Operating range in Pa is expressed as an approximate value.

Performance Characteristics for BLC Series

ALL PARAMETERS ARE MEASURED AT 1.8V EXCITATION AND ROOM TEMPERATURE UNLESS OTHERWISE SPECIFIED. PRESSURE MEASUREMENTS ARE WITH POSITIVE PRESSURE APPLIED TO PORT B (THE ONLY PORT FOR THE SINGLE PORT CONFIGURATION.) TO PORT B (THE ONLY PORT FOR THE SINGLE PORT CONFIGURATION.)

Parameter	Min	Typ	Max	Units	Notes
Output Span (FSS)					
L01D	4.5	8.0	11.5	mV	4
L05D	13.5	24.0	34.5	mV	4
L10D	18.0	32.0	46.0	mV	4
L20D	22.0	38.0	55.0	mV	4
L30D	25.0	42.0	60.0	mV	4
005D	20.0	27.5	35.0	mV	4
015D	40.0	60.0	80.0	mV	4
030D	25.0	35.0	45.0	mV	4
100D	35.0	42.5	50.0	mV	4
150D	35.0	42.5	50.0	mV	4
015A	45.0	62.5	80.0	mV	4
030A	25.0	35.0	45.0	mV	4
100A	25.0	37.5	50.0	mV	4
150A	25.0	37.5	50.0	mV	4
Offset Voltage					
L01D, L05D, L10D, L20D, L30D (@ Zero Diff. Pressure)	-	-	±10.0	mV	-
005D, 015D, 030D, 100D, 150D, 030A, 100A, 150A, 015A (@ 0 PSIA)	-	-	±15.0	mV	-
Offset Temperature Shift (0°C-70°C)					
	-	±30.0	-	μV/°C	1
Offset Warm-up Shift					
	-	±30.0	-	μV	2, 6
Offset Position Sensitivity (1g)					
	-	±20.0	-	μV	-
Linearity, Hysteresis Error					
L01D, L05D, L10D, L20D, L30D	-	-	±0.50	%FSS	3
005D, 015D, 030D, 100D, 150D, 030A, 100A, 150A	-	-	±0.30	%FSS	3
Response Time (10% to 90% Pressure Response)					
	-	100	-	μS	-
Front to Back Linearity					
	-	0.25	-	%FSS	5
Temperature Effect on Resistance (0°C-70°C)					
	-	2800	-	ppm/°C	-
Temperature Effect on Span (0°C-70°C)					
	-	-2000	-	ppm/°C	-
Input Resistance					
L01D, L05D, L10D, L20D, L30D (@ Zero Diff. Pressure)	-	3.4	-	kΩ	-
005D, 015D, 030D, 100D, 150D, 030A, 100A, 150A	-	5.0	-	kΩ	-
015A (@ 0 PSIA)	-	5.5	-	kΩ	-
Output Resistance					
L01D, L05D, L10D, L20D, L30D (@ Zero Diff. Pressure)	-	3.4	-	kΩ	-
005D, 015D, 030D, 100D, 150D, 030A, 100A, 150A	-	5.0	-	kΩ	-
015A (@ 0 PSIA)	-	5.5	-	kΩ	-

Specification Notes

NOTE 1: SHIFT IS RELATIVE TO 25°C.

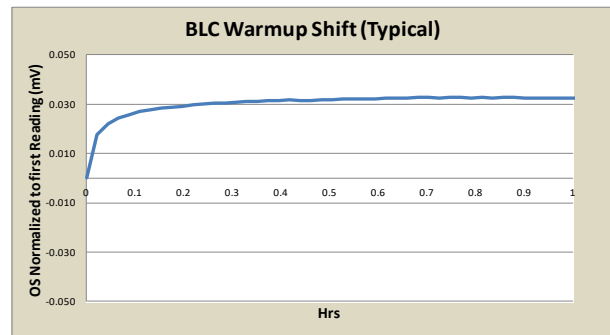
NOTE 2: SHIFT IS WITHIN THE FIRST HOUR OF EXCITATION APPLIED TO THE DEVICE.

NOTE 3: MEASURED AT ONE-HALF FULL SCALE RATED PRESSURE USING BEST STRAIGHT LINE CURVE FIT.

NOTE 4: THE SPAN IS THE ALGEBRAIC DIFFERENCE BETWEEN FULL SCALE OUTPUT VOLTAGE AND THE OFFSET VOLTAGE.

NOTE 5: FRONT-BACK LINERITY COMPUTED AS:
$$\text{Lin FB} = \left(\left| \frac{\text{Span}_{\text{PortB}}}{\text{Span}_{\text{PortA}}} \right| - 1 \right) \cdot 100\%$$

NOTE 6: TYPICAL WARM UP OF CHARACTERISTICS AS SHOWN IN GRAPH.



Soldering Recommendations

- 1) Solder parts as a second operation only.
- 2) For D4, LD2, and LD4 package post reflow, wait for 72 hrs before performing any calibration operations.
- 3) For all other packages post reflow, wait for 36 hrs before performing any calibration operations.
- 4) Perform spot cleaning as necessary only by hand. **DO NOT** wash or submerge device in cleaning liquid.
- 5) Max 270°C lead temperature (soldering 2-4 sec.)

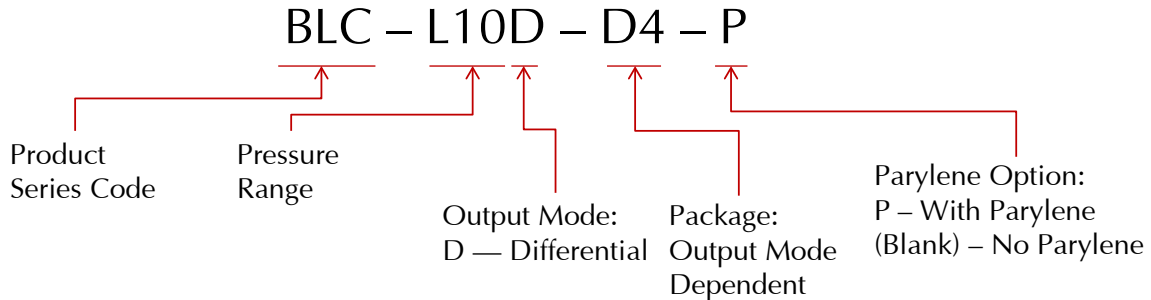
If these devices are to be subjected to solder reflow assembly or other high temperature processing, they must be baked for 1 hour at 125°C within 24 hours prior to exposure. Failure to comply may result in cracking and/or delamination of critical interfaces within the package, and is not covered by warranty.

How to Order

Refer to Table 2 for standard part numbers offered which includes the pressure range and package.

Example P/N with options: BLC-L10D-D4-P

Table 1 - Part Numbering Scheme:



Where:

Pressure Range (D4 Package – Differential Only): L01D, L05D, L10D, L20D, L30D, 005D, 015D, 030D, 100D, 150D

Pressure Range (LD2, and LD4 Packages – Differential Only): L01D, L05D, L10D, L20D, L30D

Pressure Range (U1, U2 Packages – Gage Only): L01D, L05D, L10D, L20D, L30D, 005D, 015D, 030D, 100D, 150D

Pressure Range (U4 Package – Absolute Only): 015A, 030A, 100A, 150A

Example Part Numbers:

BLC-L10D-D4-P has a Parylene coating

BLC-L10D-D4 does not have a Parylene coating

Table 2 - Standard Part Number Configurations

D and LD Packages (Differential)	Low Pressure Products	BLC - L01 - D - D4	BLC - L01 - D - LD2	BLC - L01 - D - LD4
		BLC - L05 - D - D4	BLC - L05 - D - LD2	BLC - L05 - D - LD4
		BLC - L10 - D - D4	BLC - L10 - D - LD2	BLC - L10 - D - LD4
		BLC - L20 - D - D4	BLC - L20 - D - LD2	BLC - L20 - D - LD4
		BLC - L30 - D - D4	BLC - L30 - D - LD2	BLC - L30 - D - LD4
		BLC - L30 - D - D4	BLC - L30 - D - LD2	BLC - L30 - D - LD4
	High Pressure Products	BLC - 005 - D - D4		
		BLC - 015 - D - D4		
		BLC - 030 - D - D4		
		BLC - 100 - D - D4		
		BLC - 150 - D - D4		
U Packages (Gage)	Low Pressure Products	BLC - L01 - D - U1	BLC - L01 - D - U2	
		BLC - L05 - D - U1	BLC - L05 - D - U2	
		BLC - L10 - D - U1	BLC - L10 - D - U2	
		BLC - L20 - D - U1	BLC - L20 - D - U2	
		BLC - L30 - D - U1	BLC - L30 - D - U2	
	High Pressure Products	BLC - 005 - D - U1	BLC - 005 - D - U2	
		BLC - 015 - D - U1	BLC - 015 - D - U2	
		BLC - 030 - D - U1	BLC - 030 - D - U2	
		BLC - 100 - D - U1	BLC - 100 - D - U2	
		BLC - 150 - D - U1	BLC - 150 - D - U2	
U Package (Absolute)	High Pressure Products	BLC - 015 - A - U4		
		BLC - 030 - A - U4		
		BLC - 100 - A - U4		
		BLC - 150 - A - U4		

Parylene Coating:

Parylene coating provides a moisture barrier and protection from some harsh media. Unlike other pressure sensor suppliers offering a Parylene coating, All Sensors performs this process in-house and uses an advanced production system to achieve the highest accuracy and reliability. This avoids transferring products out of and back to the pressure sensor manufacturing facility, provides complete quality control and improves the delivery time to customers. Specially designed masking techniques allow All Sensors to apply a cost-effective, high-volume Parylene coating in-house.

Consult factory for applicability of Parylene for the target application and sensor type.

This option is only available for pressure ranges of ± 10 inH₂O and above and is not available for the U4 package option.

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Product Identification for D4, U1, U2, and U4 Packages

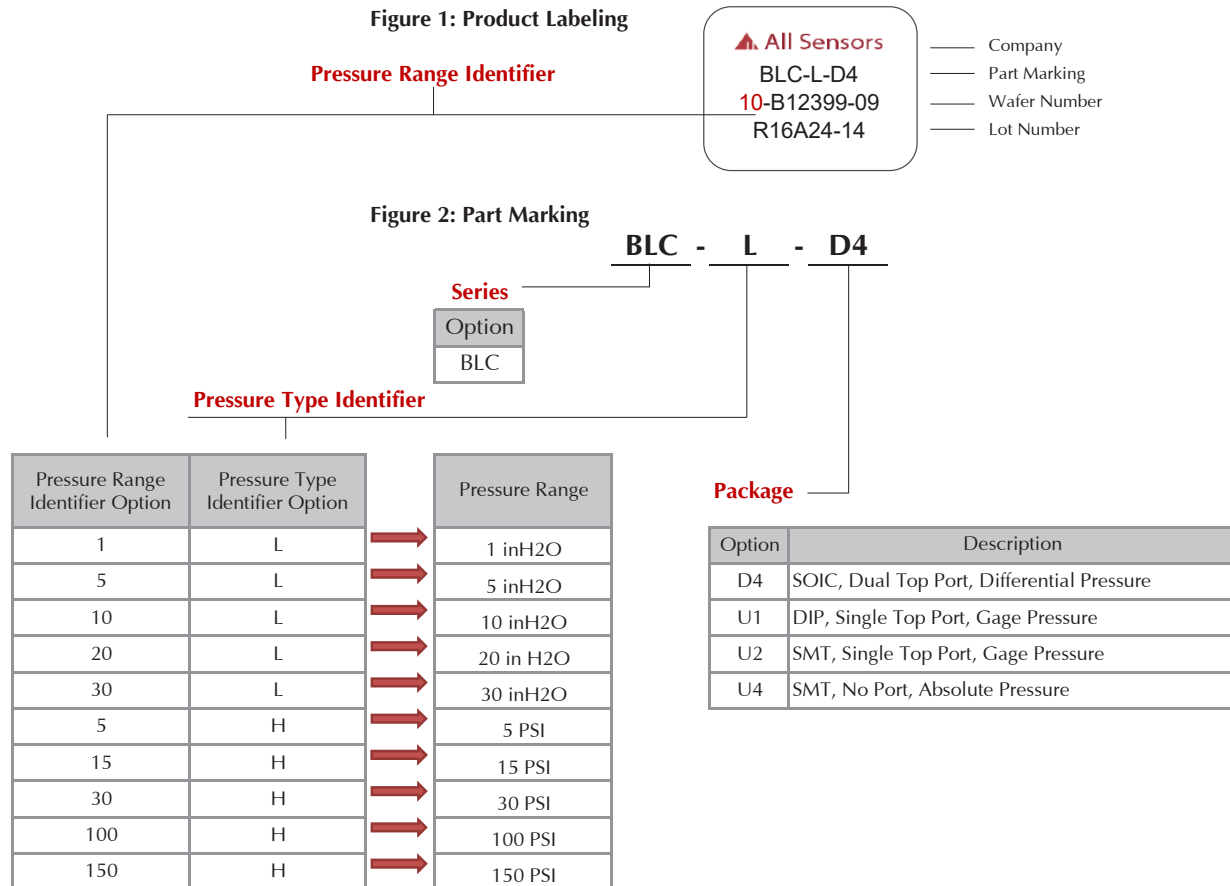
Products are labeled via laser marking, as seen in Figure 1.

Figure 2 details how to interpret the part marking code. Low pressure ranges from 1 to 30 inH₂O are specified with code "L" and high pressure ranges from 5 to 150 psi are specified with code "H"

The pressure range will be indicated on the same line as the wafer number before the starting character "B."

If parylene coated, the part will be marked with a "P" on the top. Please refer to package drawings.

Example: BLC-L10D-D4



Product Identification for LD2 and LD4 Packages

If parylene coated, the part will be marked with a "P" on the top. Please refer to package drawings.

Example: BLC-L01D-LD2

Figure 3: Product Labeling

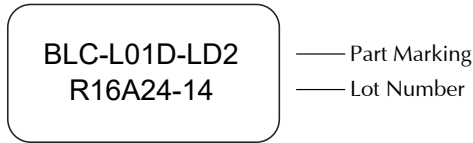
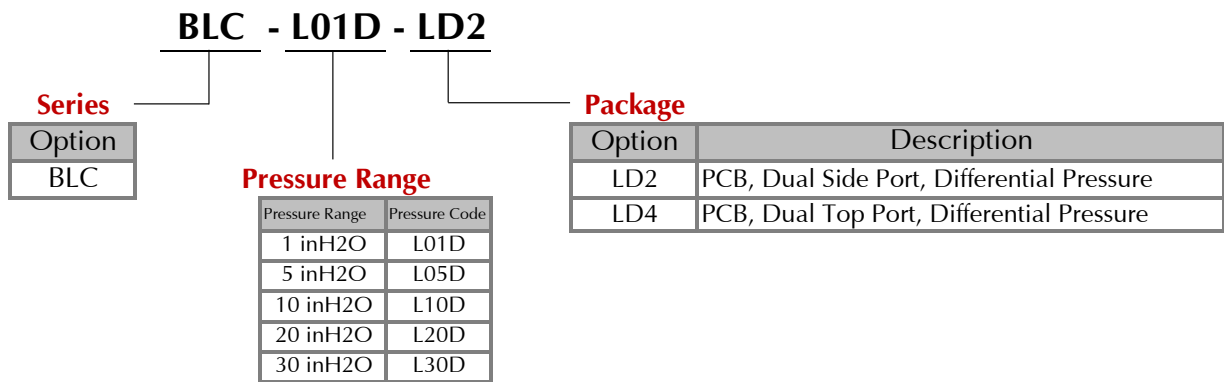
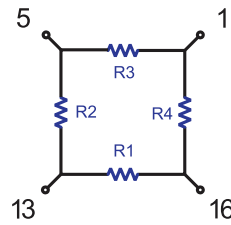
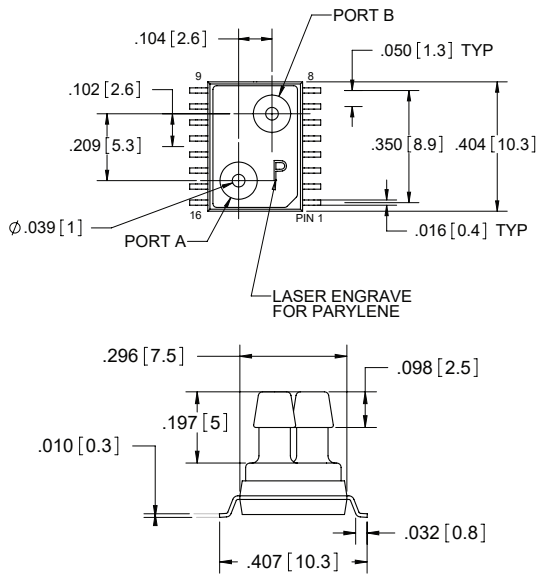


Figure 4: Part Marking

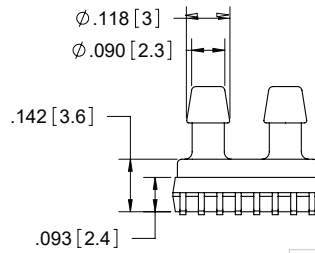


Package Drawings

D4 Package



Pin	Definition
1	-Vout
2	N/C
3	N/C
4	N/C
5	GND
6	N/C
7	N/C
8	N/C
9	N/C
10	N/C
11	N/C
12	N/C
13	+Vout
14	N/C
15	N/C
16	Vs



NOTES

- 1) Dimensions are in inches [mm].
- 2) For suggested pad layout, see drawing: PAD-22.

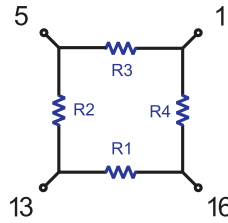
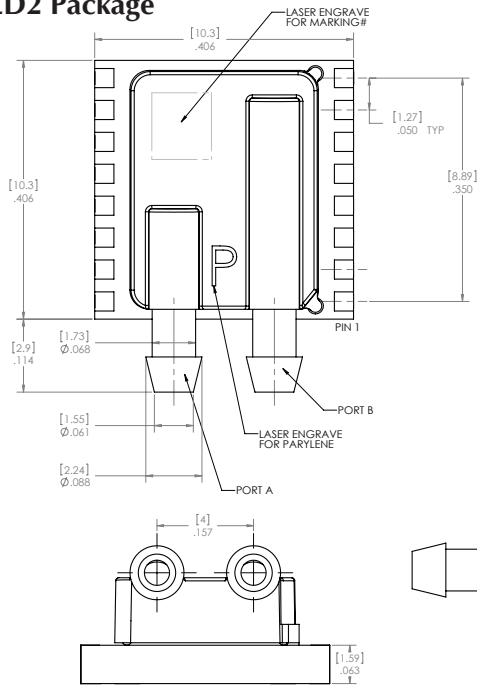
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TITLE: D-Series Package

SIZE FILE NAME
A D4 Package

Package Drawings (cont'd.)

LD2 Package



Pin	Definition
1	-Vout
2	N/C
3	N/C
4	N/C
5	GND
6	N/C
7	N/C
8	N/C
9	N/C
10	N/C
11	N/C
12	N/C
13	+Vout
14	N/C
15	N/C
16	Vs

NOTES

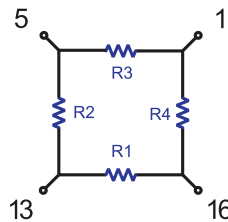
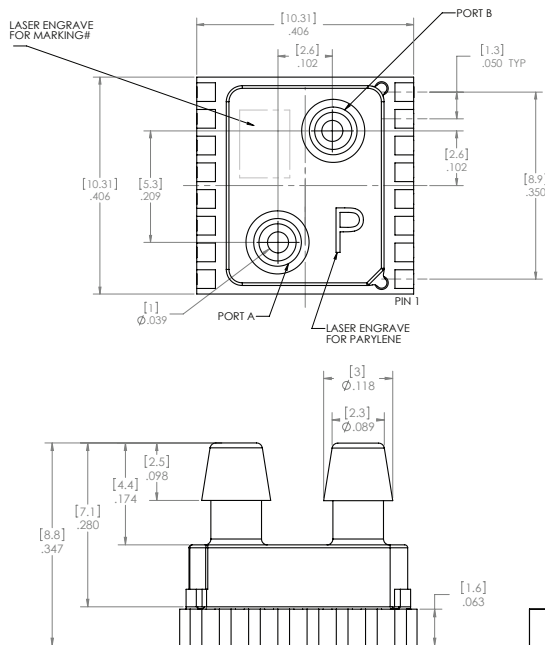
- 1) Dimensions are in inches [mm].
- 2) For suggested pad layout, see drawing: PAD-22

ALL SENSORS

TITLE: LD-Series Package

SIZE FILE NAME
A LD2 Package

LD4 Package



Pin	Definition
1	-Vout
2	N/C
3	N/C
4	N/C
5	GND
6	N/C
7	N/C
8	N/C
9	N/C
10	N/C
11	N/C
12	N/C
13	+Vout
14	N/C
15	N/C
16	Vs

NOTES

- 1) Dimensions are in inches [mm].
- 2) For suggested pad layout, see drawing: PAD-22.

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TITLE: LD-Series Package

SIZE FILE NAME
A LD4 Package

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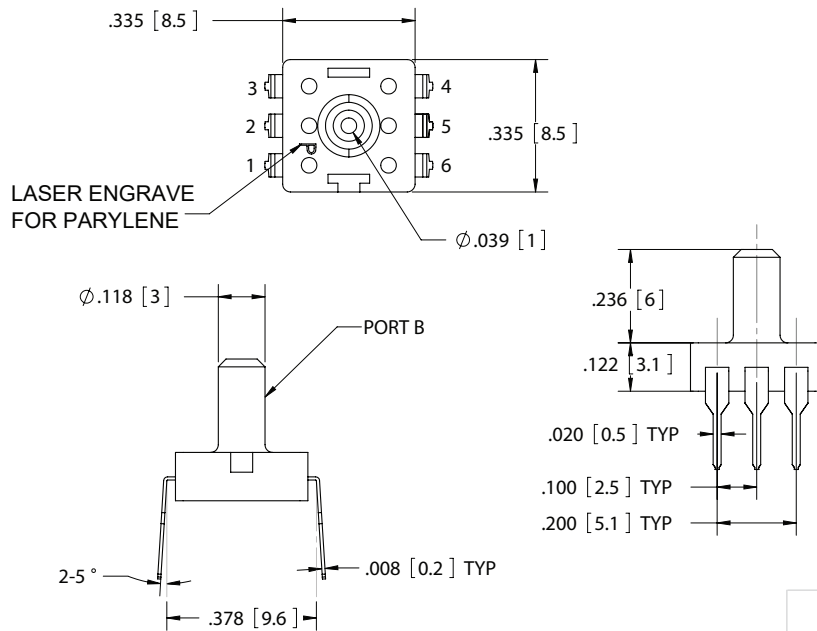
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Package Drawings (cont'd.)

U1 Package



Pin	Definition
1	+GND
2	+Vout
3	Vs
4	N/C
5	-Vout
6	-GND

NOTES

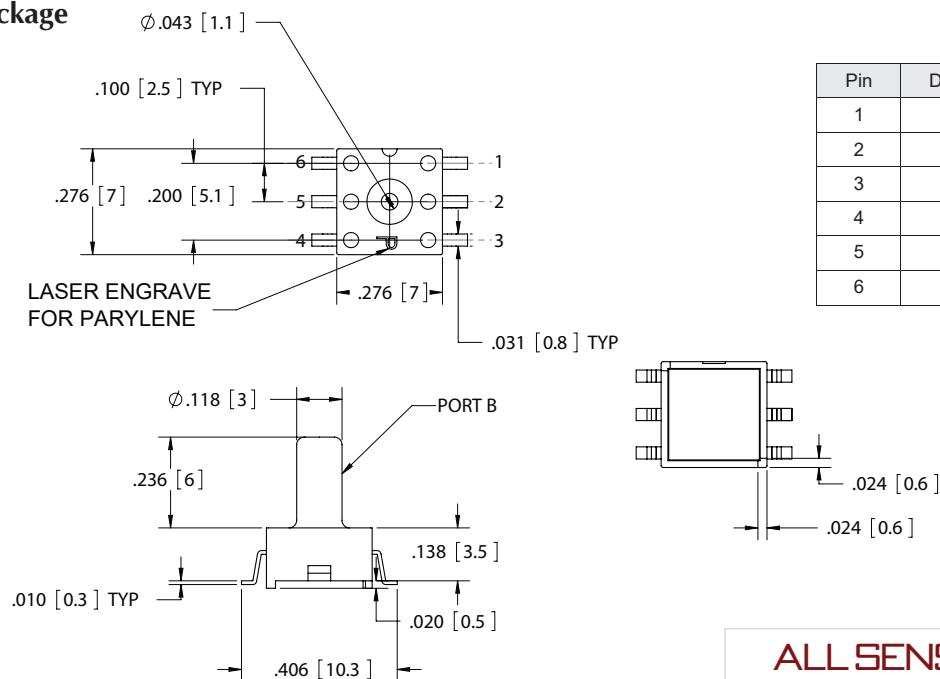
- 1) Dimensions are in inches [mm].
- 2) For suggested pad layout, see drawing: PAD-23.
- 3) Pins 1 and 6 must be connected for Gnd.

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TITLE: U-Series Package

SIZE FILE NAME
A U1 Package

U2 Package



Pin	Definition
1	+GND
2	+Vout
3	Vs
4	N/C
5	-Vout
6	-GND

NOTES

- 1) Dimensions are in inches [mm].
- 2) For suggested pad layout, see drawing: PAD-24.
- 3) Pins 1 and 6 must be connected for Gnd.

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TITLE: U-Series Package

SIZE FILE NAME
A U2 Package

Package Drawings (cont'd.)

U4 Package

The U4 package drawings include a top view showing a rectangular component with pins 1-4 on the left and 5-8 on the right. Dimensions include a width of .160 [4.1] and a height of .200 [5.1]. A circular feature has a diameter of $\varnothing .030$ [0.8]. A side view shows a height of .070 [1.8] and a width of .240 [6.1]. A detailed view of the pins shows a height of .016 [0.4] TYP, a pin width of .010 [0.3], a pin spacing of .050 [1.3] TYP, and a total pin width of .150 [3.8].

The circuit diagram shows a bridge-like configuration with resistors R1, R2, R3, and R4. R1 is between pins 2 and 8, R2 between 4 and 8, R3 between 4 and 6, and R4 between 6 and 8. Pins 1, 3, 5, and 7 are not connected.

Pin	Definition
1	N/C
2	+Vout
3	N/C
4	+GND
5	-GND
6	-Vout
7	N/C
8	Vs

NOTES

- 1) Dimensions are in mm [inches].
- 2) Offered for absolute only.
- 3) For suggested pad layout, see drawing: PAD-26
- 4) Pins 4 and 5 must be connected for Gnd.

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TITLE: U-Series Package	
SIZE: A	FILE NAME: U4 Package

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Packaging

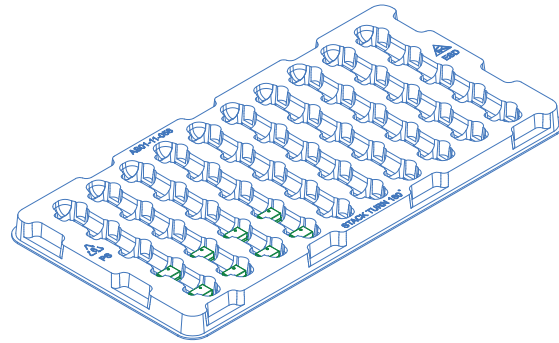
TUBE



ARROW INDICATES SIDE OF PACKAGE WHERE PIN 1 IS LOCATED

Packages: D4, U1, U2, U4

TRAY



Packages: LD2 and LD4

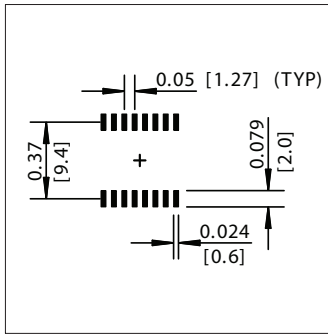
Notes

1) Contact factory for alternate packing options.

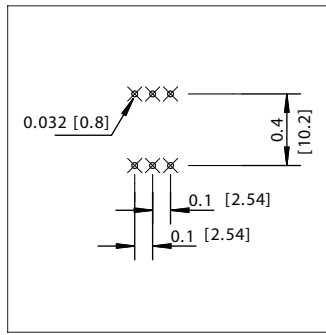
Pressure Tubing Recommendations

Tubing Recommendations				
Package Type	ID	OD	Material	
			Low Pressure	High Pressure
D4	1/16"	1/8"	Silicone	Polyurethane
LD2	1/16"	1/8"	Silicone	Polyurethane
LD4	1/16"	1/8"	Silicone	Polyurethane
U1	3/32"	5/32"	Silicone	Polyurethane
U2	3/32"	5/32"	Silicone	Polyurethane

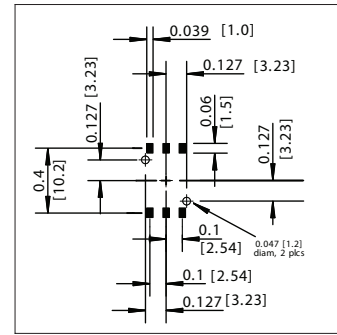
Suggested Pad Layouts



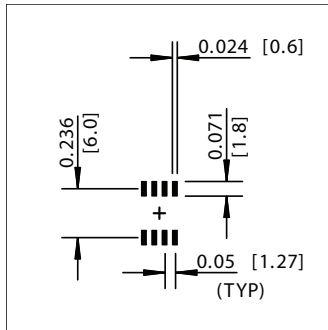
PAD-22



PAD-23



PAD-24



PAD-26

Dimensions are in inches [mm].

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